

IRFU9014PBF-VB Datasheet P-Channel 60-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|--|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}$ (Ω) | I _D (A) ^a | Q _g (Typ.) | | | |
| - 60 | 0.066 at V _{GS} = - 10 V | - 20 | 40 nC | | | |
| | $0.080 \text{ at V}_{GS} = -4.5 \text{ V}$ | - 18 | 40110 | | | |

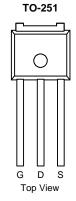
FEATURES

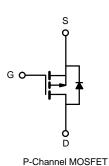
- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch







| Parameter | Symbol | Limit | Unit | | |
|--|-----------------------------------|------------------|--------------------|-----|--|
| Drain-Source Voltage | V _{DS} | - 60 | V | | |
| Gate-Source Voltage | V _{GS} | ± 20 | | | |
| | T _C = 25 °C | | - 20 ^a | | |
| Continuous Proin Current (T. – 150 °C) | T _C = 70 °C | , [| - 16 | | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | I _D | - 11 ^b | ٨ | |
| | T _A = 70 °C | | - 9 ^b | Α | |
| Pulsed Drain Current | I _{DM} | - 100 | | | |
| Avalanche Current Pulse | L = 0.1 mH | I _{AS} | - 35 | | |
| Single Pulse Avalanche Energy | L = 0.1 min | E _{AS} | 101 | mJ | |
| | T _C = 25 °C | | - 29 ^a | ۸ | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | l _s – | - 2.1 ^b | Α | |
| Maximum Power Dissipation | T _C = 25 °C | | 35 ^a | | |
| | T _C = 70 °C | ь Г | 20 ^a | 147 | |
| | T _A = 25 °C | P _D | 3.0 ^b | W | |
| | T _A = 70 °C | | 2 ^b | | |
| Operating Junction and Storage Temperature R | T _J , T _{stg} | - 55 to 150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|---------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^b | Steady State | R_{thJA} | 33 | 40 | °C/W | |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 0.98 | 1.2 | - °C/VV | |

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|--|-------|-------|----------|-----------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | - 60 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | / _{DS} /T _J | | 68 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | η – - 250 μΑ | | - 5.2 | |] 11107 C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1.0 | | - 2.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| Zana Cata Valta na Busin Commant | , | V _{DS} = - 60 V, V _{GS} = 0 V | | | - 1 | ^ | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 55 °C | | | - 10 | μA | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = - 5 V, V _{GS} = - 10 V | - 120 | | | Α | |
| | | V _{GS} = - 10 V, I _D = - 30 A | | 0.066 | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 20 A | | 0.080 | | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 50 A | 20 | | | S | |
| Dynamic ^b | | | | | <u> </u> | · | |
| Input Capacitance | C _{iss} | | | 1200 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz | | 200 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 150 | | | |
| Total Oats Observe | Qg | V _{DS} = -30 V, V _{GS} = -10 V, I _D = -55 A | | 40 | | | |
| Total Gate Charge | | | | 38 | | nC | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -55 \text{ A}$ | | 16 | | | |
| Gate-Drain Charge | Q_{gd} | | | 19 | | | |
| Gate Resistance | R _g | f = 1 MHz | | 5.2 | | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | | |
| Rise Time | t _r | $V_{DD} = -2 \text{ V}, R_{L} = 2 \Omega$ | | 7 | 15 | ns | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 70 | 110 | | |
| Fall Time | t _f | | | 40 | 60 | | |
| Drain-Source Body Diode Characteristic | s | | | | L | l | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 66 | | |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 150 | A | |
| Body Diode Voltage | V _{SD} | I _S = - 30 A | | - 1 | - 1.5 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 45 | 68 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 59 | 120 | nC | |
| Reverse Recovery Fall Time | t _a | $I_F = -50 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$ | | 29 | | | |
| verse Recovery Rise Time t _b | | | | 16 | | ns | |

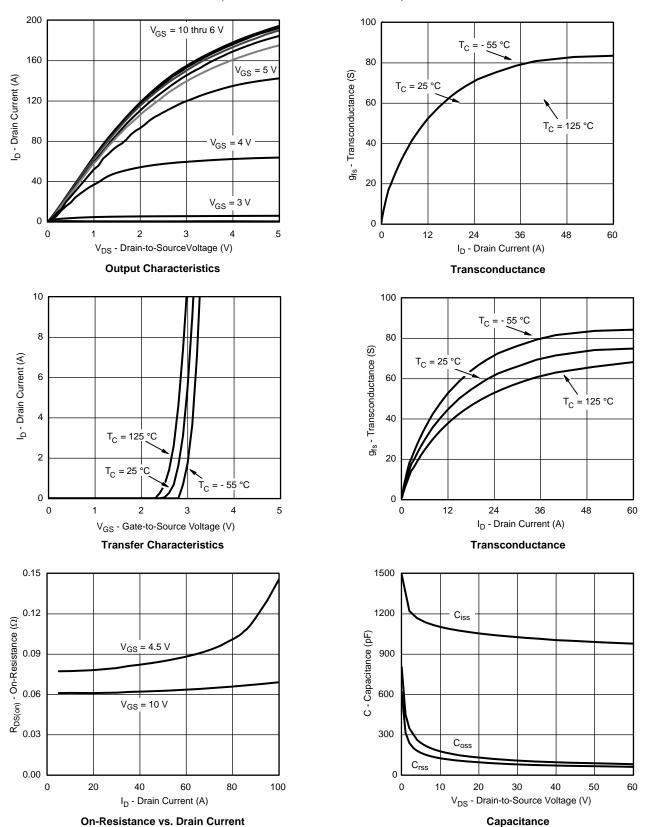
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

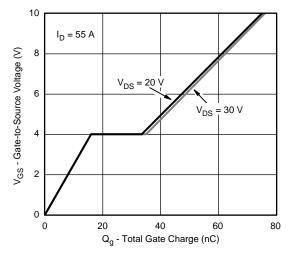


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

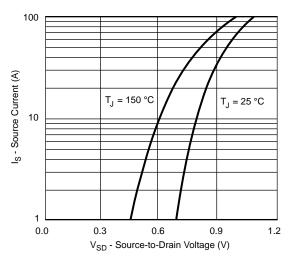




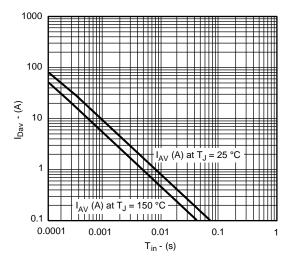
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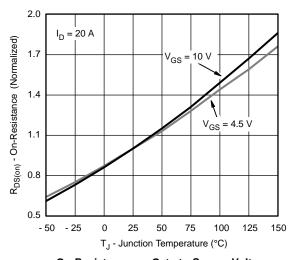




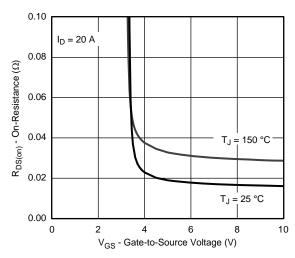
Source-Drain Diode Forward Voltage



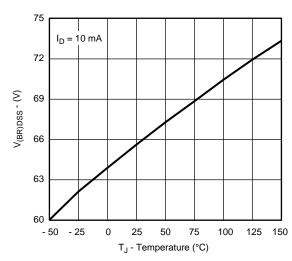
Single Pulse Avalanche Current Capability vs. Time



On-Resistance vs. Gate-to-Source Voltage



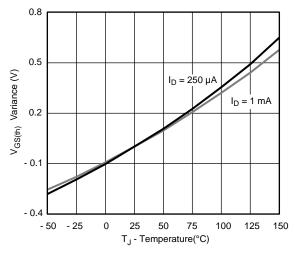
On-Resistance vs. Gate-to-Source Voltage

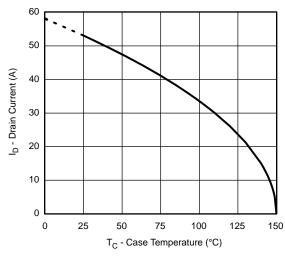


Drain-Source Breakdown Voltage vs. Junction Temperature

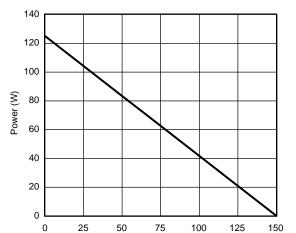


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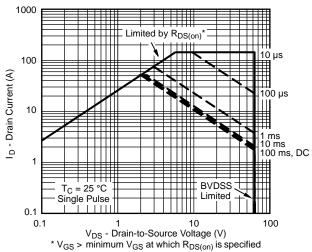




Threshold Voltage

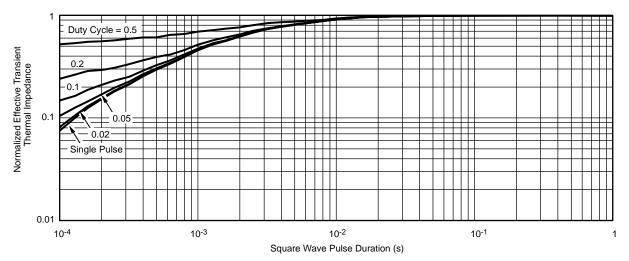


Max. Drain Current vs. Case Temperature



 $\label{eq:TJ-Temperature continuous} T_J \text{ - Temperature (°C)}$ Power Derating, Junction-to-Case



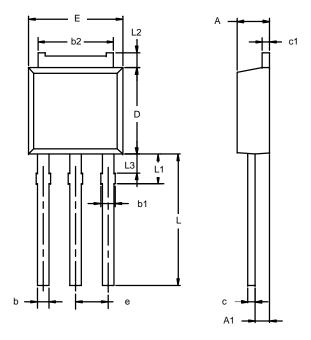


Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788 5



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

| | MILLIM | IETERS | INC | HES | |
|---|----------|--------|-----------|-------|--|
| Dim | Min | Max | Min | Max | |
| Α | 2.21 | 2.38 | 0.087 | 0.094 | |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 | |
| b | 0.71 | 0.89 | 0.028 | 0.035 | |
| b1 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b2 | 5.23 | 5.43 | 0.206 | 0.214 | |
| С | 0.46 | 0.58 | 0.018 | 0.023 | |
| с1 | 0.46 | 0.58 | 0.018 | 0.023 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| E | 6.48 | 6.73 | 0.255 | 0.265 | |
| е | 2.28 BSC | | 0.090 BSC | | |
| L | 8.89 | 9.53 | 0.350 | 0.375 | |
| L1 | 1.91 | 2.28 | 0.075 | 0.090 | |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L3 | 1.15 | 1.52 | 0.045 | 0.060 | |
| ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346 | | | | | |



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